



# PMP5501Y-Q

45 V, 100 mA PNP/PNP matched double transistor

12 September 2025

Product data sheet

## 1. General description

PNP/PNP matched double transistor in a very small SOT363 (SC-88) Surface-Mounted Device (SMD) plastic package.

PNP/PNP  $h_{FE1}/h_{FE2}$  0.98 complement: PMP5201Y-Q

NPN/NPN complement: PMP4501Y-Q

## 2. Features and benefits

- Current gain matching
- Base-emitter voltage matching
- Application-optimized pinout
- Qualified according to AEC-Q101 and recommended for use in automotive applications

## 3. Applications

- Current mirror
- Differential amplifier

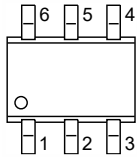
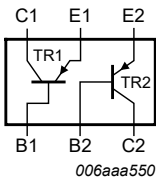
## 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>Per transistor</b>						
$V_{CE0}$	collector-emitter voltage	open base	-	-	-45	V
$I_C$	collector current		-	-	-100	mA
$h_{FE}$	DC current gain	$V_{CE} = -5\text{ V}$ ; $I_C = -2\text{ mA}$ ; $T_{amb} = 25\text{ °C}$	200	290	450	
<b>Per device</b>						
$h_{FE1}/h_{FE2}$	DC current gain matching	$V_{CE} = -5\text{ V}$ ; $I_C = -2\text{ mA}$ ; $T_{amb} = 25\text{ °C}$	0.95	1	-	
$V_{BE1}-V_{BE2}$	base-emitter voltage matching		-	-	2	mV

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	B1	base TR1	 TSSOP6 (SOT363)	 006aaa550
2	B2	base TR2		
3	C2	collector TR2		
4	E2	emitter TR2		
5	E1	emitter TR1		
6	C1	collector TR1		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PMP5501Y-Q	TSSOP6	plastic, surface-mounted package; 6 leads; 0.65 mm pitch; 2.1 mm x 1.25 mm x 0.95 mm body	SOT363

7. Marking

Table 4. Marking codes

Type number	Marking code[1]
PMP5501Y-Q	S6%

[1] % = placeholder for manufacturing site code

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
Per transistor						
V <sub>CBO</sub>	collector-base voltage	open emitter		-	-50	V
V <sub>CEO</sub>	collector-emitter voltage	open base		-	-45	V
V <sub>EBO</sub>	emitter-base voltage	open collector		-	-5	V
I <sub>C</sub>	collector current			-	-100	mA
I <sub>CM</sub>	peak collector current	single pulse; t <sub>p</sub> ≤ 1 ms		-	-200	mA
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[1] [2]	-	200	mW
Per device						
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[1] [2]	-	300	mW
T <sub>j</sub>	junction temperature			-	150	°C
T <sub>amb</sub>	ambient temperature			-65	150	°C
T <sub>stg</sub>	storage temperature			-65	150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Reflow soldering is the only recommended soldering method.

## 9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
<b>Per transistor</b>							
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1] [2]	-	-	625	K/W
<b>Per device</b>							
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1] [2]	-	-	416	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Reflow soldering is the only recommended soldering method.

## 10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Per transistor							
I <sub>CBO</sub>	collector-base cut-off current	V <sub>CB</sub> = -30 V; I <sub>E</sub> = 0 A; T <sub>amb</sub> = 25 °C		-	-	-15	nA
		V <sub>CB</sub> = -30 V; I <sub>E</sub> = 0 A; T <sub>j</sub> = 150 °C		-	-	-5	μA
I <sub>EBO</sub>	emitter-base cut-off current	V <sub>EB</sub> = -5 V; I <sub>C</sub> = 0 A; T <sub>amb</sub> = 25 °C		-	-	-100	nA
h <sub>FE</sub>	DC current gain	V <sub>CE</sub> = -5 V; I <sub>C</sub> = -10 μA; T <sub>amb</sub> = 25 °C		-	250	-	
		V <sub>CE</sub> = -5 V; I <sub>C</sub> = -2 mA; T <sub>amb</sub> = 25 °C		200	290	450	
V <sub>CEsat</sub>	collector-emitter saturation voltage	I <sub>C</sub> = -10 mA; I <sub>B</sub> = -0.5 mA; T <sub>amb</sub> = 25 °C		-	-50	-200	mV
		I <sub>C</sub> = -100 mA; I <sub>B</sub> = -5 mA; T <sub>amb</sub> = 25 °C		-	-200	-400	mV
V <sub>BEsat</sub>	base-emitter saturation voltage	I <sub>C</sub> = -10 mA; I <sub>B</sub> = -0.5 mA; T <sub>amb</sub> = 25 °C	[1]	-	-760	-	mV
		I <sub>C</sub> = -100 mA; I <sub>B</sub> = -5 mA; T <sub>amb</sub> = 25 °C	[1]	-	-920	-	mV
V <sub>BE</sub>	base-emitter voltage	V <sub>CE</sub> = -5 V; I <sub>C</sub> = -2 mA; T <sub>amb</sub> = 25 °C	[2]	-600	-650	-700	mV
		V <sub>CE</sub> = -5 V; I <sub>C</sub> = -10 mA	[2]	-	-	-760	mV
C <sub>c</sub>	collector capacitance	V <sub>CB</sub> = -10 V; I <sub>E</sub> = 0 A; i <sub>e</sub> = 0 A; f = 1 MHz; T <sub>amb</sub> = 25 °C		-	-	2.2	pF
C <sub>e</sub>	emitter capacitance	V <sub>EB</sub> = -0.5 V; I <sub>C</sub> = 0 A; i <sub>c</sub> = 0 A; f = 1 MHz; T <sub>amb</sub> = 25 °C		-	10	-	pF
f <sub>T</sub>	transition frequency	V <sub>CE</sub> = -5 V; I <sub>C</sub> = -10 mA; f = 100 MHz; T <sub>amb</sub> = 25 °C		100	175	-	MHz
NF	noise figure	V <sub>CE</sub> = -5 V; I <sub>C</sub> = -0.2 mA; R <sub>S</sub> = 2 kΩ; f = 10 Hz to 15.7 kHz; T <sub>amb</sub> = 25 °C		-	1.6	-	dB
		V <sub>CE</sub> = -5 V; I <sub>C</sub> = -0.2 mA; R <sub>S</sub> = 2 kΩ; f = 1 kHz; B = 200 Hz		-	3.1	-	dB
Per device							
h <sub>FE1</sub> /h <sub>FE2</sub>	DC current gain matching	V <sub>CE</sub> = -5 V; I <sub>C</sub> = -2 mA; T <sub>amb</sub> = 25 °C		0.95	1	-	
V <sub>BE1</sub> -V <sub>BE2</sub>	base-emitter voltage matching			-	-	2	mV

[1]  $V_{BEsat}$  decreases by about 1.7 mV/K with increasing temperature.

[2]  $V_{BE}$  decreases by about 2 mV/K with increasing temperature.

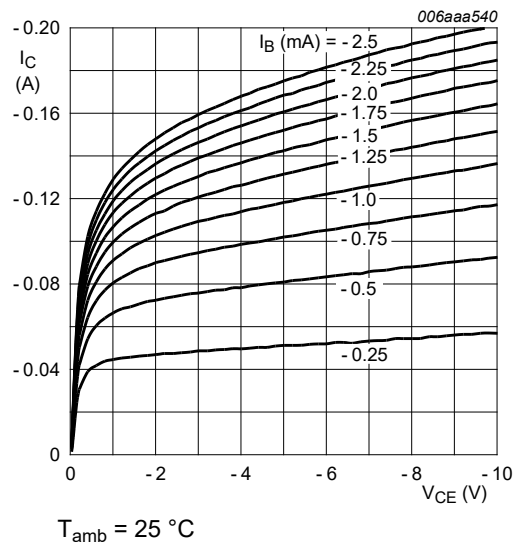


Fig. 1. Per transistor: Collector current as a function of collector-emitter voltage; typical values

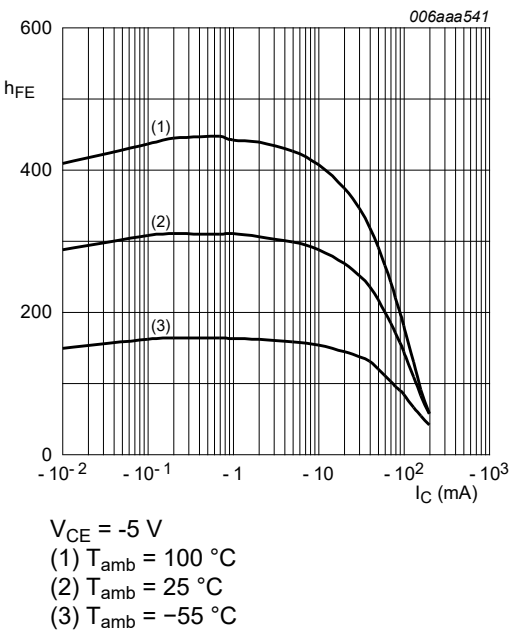


Fig. 2. Per transistor: DC current gain as a function of collector current; typical values

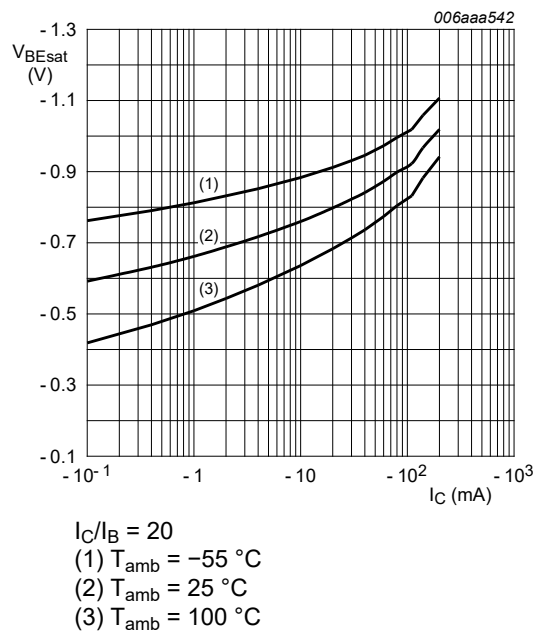


Fig. 3. Per transistor: Base-emitter saturation voltage as a function of collector current; typical values

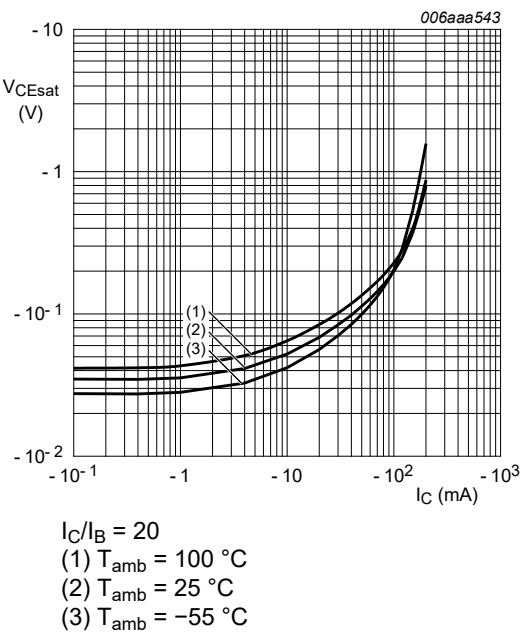


Fig. 4. Per transistor: Collector-emitter saturation voltage as a function of collector current; typical values

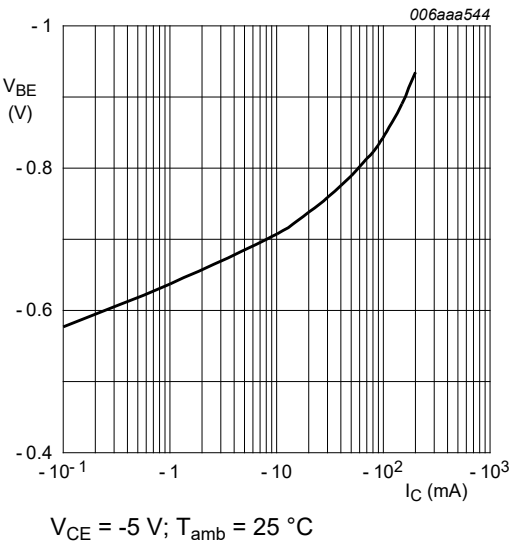


Fig. 5. Per transistor: Base-emitter voltage as a function of collector current; typical values

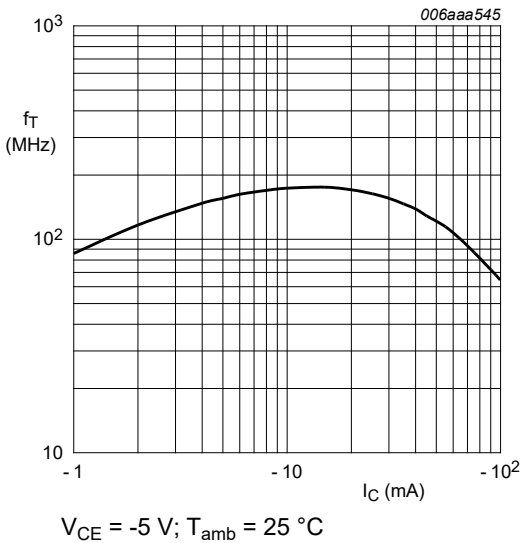


Fig. 6. Per transistor: Transition frequency as a function of collector current; typical values

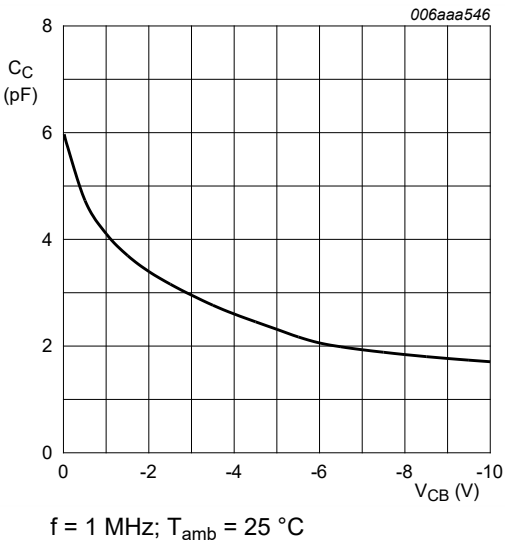


Fig. 7. Per transistor: Collector capacitance as a function of collector-base voltage; typical values

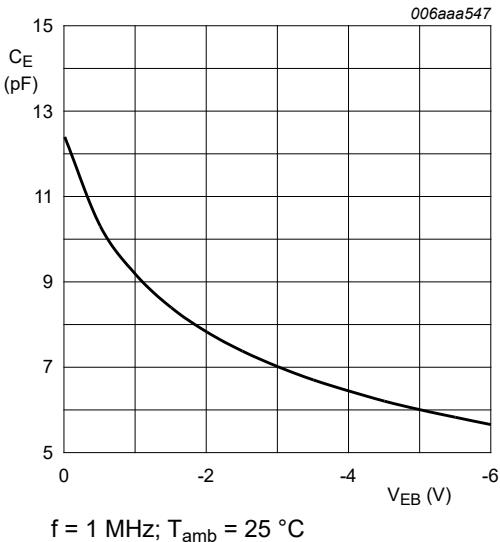


Fig. 8. Emitter capacitance as a function of emitter-base voltage; typical values

11. Application information

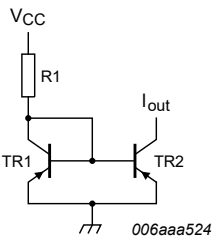


Fig. 9. Current mirror

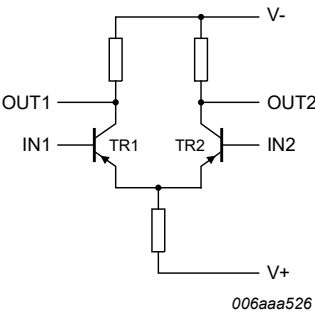


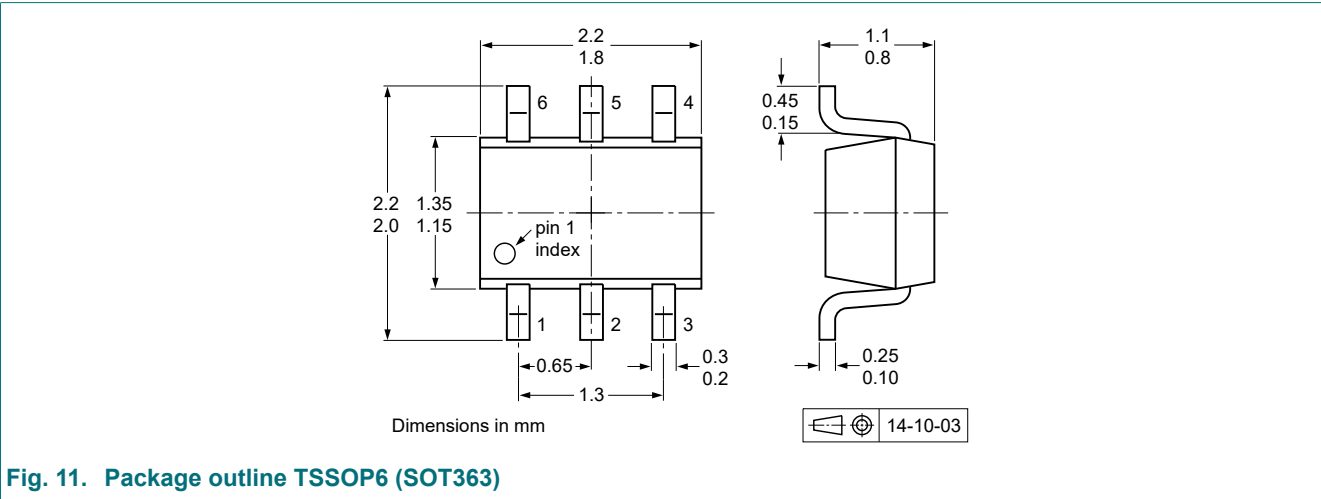
Fig. 10. Differential amplifier

12. Test information

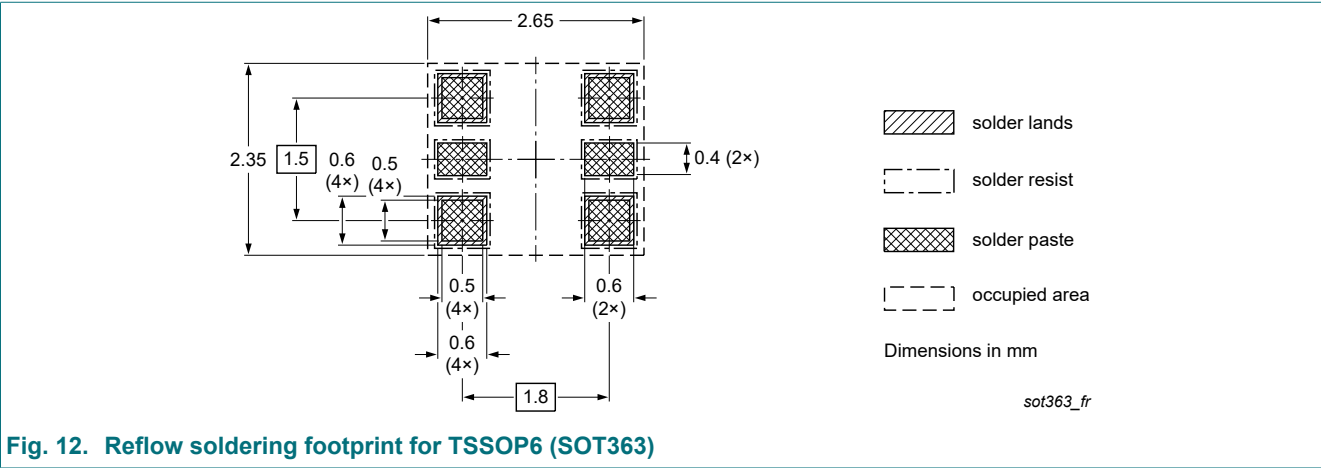
Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 -Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

13. Package outline



14. Soldering



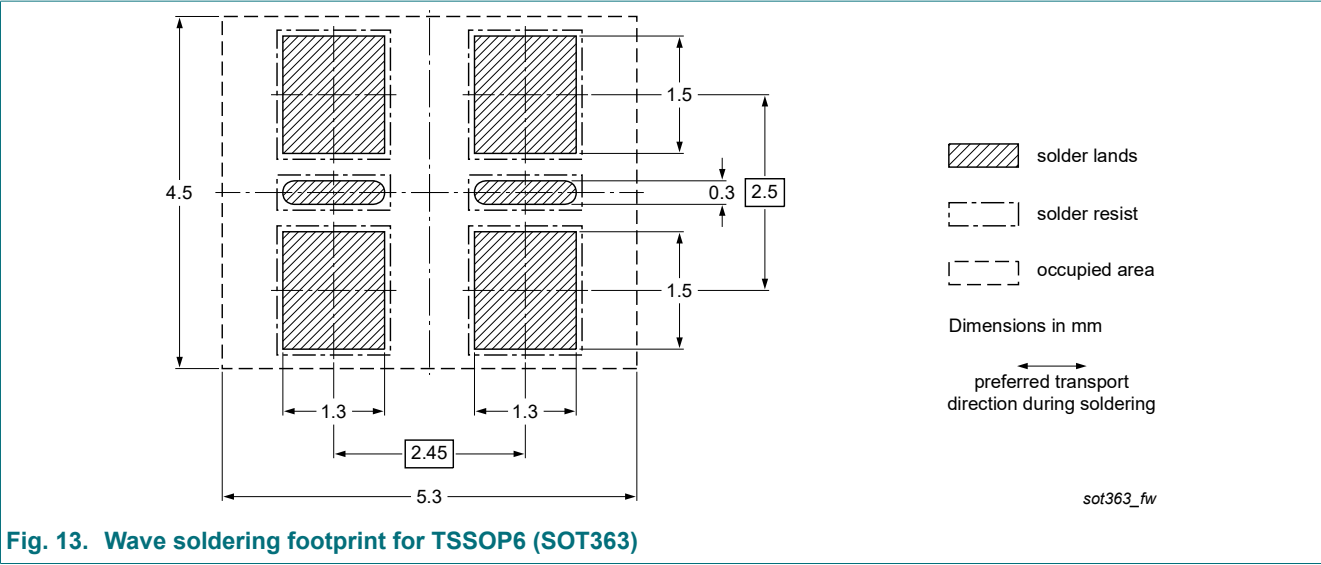


Fig. 13. Wave soldering footprint for TSSOP6 (SOT363)

15. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PMP5501Y-Q v.1	20250912	Product data sheet	-	-



## 16. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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Contents

1. General description..... 1

2. Features and benefits..... 1

3. Applications..... 1

4. Quick reference data..... 1

5. Pinning information.....2

6. Ordering information.....2

7. Marking.....2

8. Limiting values..... 2

9. Thermal characteristics..... 3

10. Characteristics..... 3

11. Application information.....5

12. Test information.....6

13. Package outline..... 6

14. Soldering..... 6

15. Revision history.....8

16. Legal information.....9

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